

Evaluation Kit

APPLICABLE PARTS (SOLD SEPARATELY)

• PA107

INTRODUCTION

The EK71 Evaluation kit is designed to provide a convenient way to breadboard and evaluate design ideas for the PA107 power operational amplifier. The evaluation board is pre-wired for all required external components. The evaluation board has been laid out and labeled to easily configure the high voltage operational amplifier in an inverting configuration. However, the evaluation board is flexible enough to analyze a multi-tude of standard or proprietary circuit configurations. Components not usually readily available in engineering labs are provided. External connection to the evaluation kit can be made via the terminal connectors at the edge of the circuit board. These connectors are suitable for standard banana plugs. The schematic is shown in Figure 1.







PARTS LIST

Reference	Manufacturer Part #	Description	QTY
P1	146510CJ	Connector, BNC, PCB Mount	1
P2, P3, P4, P5, P6, P7, P8	571-0100	4mm Black PCB Socket Single	9
C ₄ , C ₆	KMH200VN68IM25X40T2	Capacitor, 680 μF	2
	EVAL71	PC Board	1
	HS20	Heatsink	1
	310-43-120-41-001000	Mating Socket	1
C ₂ , C ₇ , C ₅ , C ₃	OX7R105KWN	Cap, 1µF	4
	TW07	Thermal Washer, PSIP	1

BEFORE YOU GET STARTED

- Please read this data sheet in its entirety before starting to construct your evaluation board.
- All Apex Microtechnology amplifiers should be handled using proper ESD precautions.
- Do not change connections while the circuit is powered.
- Initially set all power supplies to the minimum operating voltage allowed in the device data sheet.
- Always use adequate power supply bypass capacitors, Apex Microtechnology recommends 1µF (ceramic) in parallel with at least 10µF per ampere of output current (electrolytic/tantalum).
- Always provide the adequate heat sinking. Power dissipation must be considered to ensure maximum junction temperature is not exceeded.
- Check for oscillations.
- Please refer to Application Note, AN01 for general operating considerations.

ASSEMBLY

- 1. See Figure 1 and Figure 2. Solder the surface mount ceramic capacitors to the DUT side of the circuit board at C2, C7, C5 and C3.
- 2. Clip off the mating socket strip after the 12th position. Insert the strip into the circuit board from the DUT side and solder one pin on the reverse side. Check that the mating socket strip is fully seated against the circuit board then solder the remaining pins. Insert the amplifier fully into the mating socket strip, noting the pin 1 locations on the amplifier and the circuit board.
- 3. To select the values of feedback resistor (RFB), feedback capacitor (CFB) and summing junction capacitor (CSJ), please refer to the section titled "FEEDBACK CONSIDERATIONS" in the PA107DP data sheet.
- 4. C1 and C8 are user supplied pin-through-hole bypass capacitors for Vcc and Vee respectively. Insert C1 and C8 from the component side and solder from the circuit side.
- 5. Add other components as necessary to complete your application circuit.
- 6. Solder the electrolytic capacitors to the circuit board at C4 and C6. Match the polarity markings on the circuit board with those on the capacitor body.
- 7. Examine the large heat sink. Notice that there are several holes in the face of the heat sink. These are for mounting various Apex Microtechnology amplifier models. The circuit board aligns the amplifier with the correct mounting hole once the heat sink is attached to the circuit board.
- 8. The four holes at the corners of the circuit board are for mounting #6 standoff spacers if desired. The remaining two slotted holes are for mounting the large heat sink to the DUT side of the circuit board. Temporarily mount the heat sink with 2 #6 x 1/2" [3 x 15mm] self tapping screws from the opposite side of the circuit board. Do not fully tighten the screws at this time. Check for alignment of the slot in the



mounting tab of the amplifier with a hole in the heat sink. Dismount and rotate the heat sink if necessary to achieve an alignment with a hole in the heat sink. Position the heat sink so that the back of the amplifier mounting tab is flush with the heat sink then tighten the heat sink mounting screws.

9. Hang the thermal washer near the end of a $6-32 \times 1/2''$ [M4 X 15mm] screw. Slightly pull the amplifier away from the heat sink face. Use the screw to position the thermal washer behind the amplifier and insert the screw into the mounting hole of the heat sink. Secure the screw from the opposite side of the heat sink using a nut holder.



Figure 2: EK71 Assembly



Figure 3: EVAL71 PCB Layout







NEED TECHNICAL HELP? CONTACT APEX SUPPORT!

For all Apex Microtechnology product questions and inquiries, call toll free 800-546-2739 in North America. For inquiries via email, please contact apex.support@apexanalog.com. International customers can also request support by contacting their local Apex Microtechnology Sales Representative. To find the one nearest to you, go to www.apexanalog.com

IMPORTANT NOTICE

Apex Microtechnology, Inc. has made every effort to insure the accuracy of the content contained in this document. However, the information is subject to change without notice and is provided "AS IS" without warranty of any kind (expressed or implied). Apex Microtechnology reserves the right to make changes without further notice to any specifications or products mentioned herein to improve reliability. This document is the property of Apex Microtechnology and by furnishing this information, Apex Microtechnology grants no license, expressed or implied under any patents, mask work rights, copyrights, trademarks, trade secrets or other intellectual property rights. Apex Microtechnology owns the copyrights associated with the information contained herein and gives consent for copies to be made of the information only for use within your organization with respect to Apex Microtechnology integrated circuits or other products of Apex Microtechnology. This consent does not extend to other copying such as copying for general distribution, advertising or promotional purposes, or for creating any work for resale.

APEX MICROTECHNOLOGY PRODUCTS ARE NOT DESIGNED, AUTHORIZED OR WARRANTED TO BE SUITABLE FOR USE IN PRODUCTS USED FOR LIFE SUPPORT, AUTOMOTIVE SAFETY, SECURITY DEVICES, OR OTHER CRITICAL APPLICATIONS. PRODUCTS IN SUCH APPLICATIONS ARE UNDERSTOOD TO BE FULLY AT THE CUSTOMER OR THE CUSTOMER'S RISK.

Apex Microtechnology, Apex and Apex Precision Power are trademarks of Apex Microtechnology, Inc. All other corporate names noted herein may be trademarks of their respective holders.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Development Boards & Kits - Other Processors category:

Click to view products by Apex Microtechnology manufacturer:

Other Similar products are found below :

KIT_AURIX_TC233LP_TRB_EVB-MEC1418MECC_P1020RDB-PD_STM8S/32-D/RAIS_T4240QDS-PB_RTE510Y470TGB00000R SPC58EEMU_YR0K50571MS000BE_YQB-R5F1057A-TB_QB-R5F104PJ-TB_RTE510MPG0TGB00000R_YRPBRX71M_OV-7604-C7-EVALUATION-BOARD_SK-AD02-D62Q1747TB_ST7MDT1-EMU2_RTK5572TKCS00000BE_KITAURIXTC234TFTTOBO1_SL-MIPI-LVDS-HDMI-CNV4_QB-R5F104LE-TB_R0K521380S000BE_LV-24-33_V6 44-PIN_TQFP_MCU_CARD_EMPTY_LV-24-33_V6 64-PIN_TQFP MCU_CARD_EMPTY_LV-24-33_V6 80-PIN_TQFP 1_MCU_CARD_EMPTY_32X32_RGB_LED_MATRIX_PANEL - 6MM_PITCH_READY_FOR XMEGA_CASING (WHITE)_RELAY4_BOARD_ETHERNET_CONNECTOR_RFID_CARD_125KHZ - TAG_RFID_READER_RFM12B-DEMO_MAROON_MAX232_MAX3232_BOARD_ARTY_S7-50_THREE-AXIS_ACCELEROMETER_BOARD_TINKERKIT_HALL_SENSOR TOUCHPANEL_CONTROLLER_MIKROBOARD_FOR_AVR_WITH_ATMEGA128_MIKROBOARD_FOR_PSOC_WITH_CY8C27643 MIKROBUS_CAPE_MIKRODRIVE_MIKROETH_100_BOARD_MIKROPROG_TO_ST-LINK_V2_ADAPTER_BANANA_PI GPIO_EXTEND MODULE_BATTERY_BOOST_SHIELD_BOARD_BEE_PROTO_BIGDSPIC6_80-PIN_TQFP_1_MCU_CARD_EMPTY_BIPOLAR_STEPPER_ MOTOR_DRIVER_MOD-28.Z_MOD-30.Z